

DATA SHEET

SKY65173-70LF: 869 to 960 MHz Low-Noise Linear Power Amplifier Driver

Applications

- 2.5G, 3G, and 4G transceivers
- ISM band transceivers
- WCS fixed wireless
- 3GPP LTE

Features

- Wideband frequency range: 869 to 960 MHz
- Low Noise Figure: < 2.6 dB typical
- High IIP3: > +44 dBm typical
- Output P1dB: +26.5 dBm typical
- High gain: > 16.5 dB typical
- Single DC supply: +5 V
- On-chip bias circuit
- SOT-89 (4-pin, 2.4 x 4.5 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

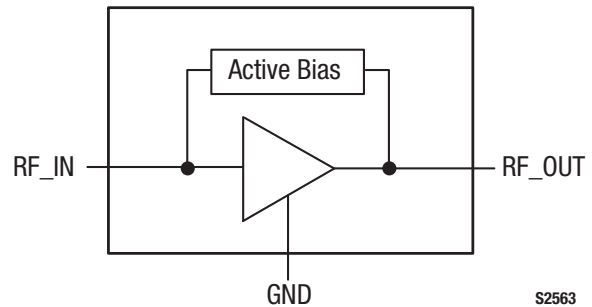


Figure 1. SKY65173-70LF Functional Block Diagram

Description

Skyworks SKY65173-70LF is a high performance, wideband, low-noise, highly linear Power Amplifier (PA) driver. The device provides a 2.6 dB Noise Figure (NF) and an output power at 1 dB compression of +26.5 dBm, making the SKY65173-70LF ideal for use in the driver stage of infrastructure transmit chains.

The SKY65173-70LF uses low-cost Surface-Mount Technology (SMT) in the form of a 4-pin, 2.4 x 4.5 mm Small Outline Transistor (SOT-89) package. A functional block diagram is provided in Figure 1 and the device package and pinout are shown in Figure 2.

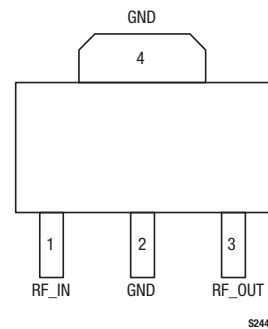


Figure 2. SKY65173-70LF Pinout – 4-Pin SOT-89 Package (Top View)

Table 1. SKY65173-70LF Signal Descriptions

Pin	Name	Description
1	RF_IN	RF input
2	GND	Ground
3	RF_OUT	RF output
4	GND	Ground

Table 2. SKY65173-70LF Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units
Supply voltage	V _{CC}		6	V
RF input power	P _{IN}		+10	dBm
Supply current	I _{CC}		300	mA
Power dissipation	P _D		1.7	W
Operating case temperature	T _C	-40	+85	°C
Storage temperature	T _{ST}	-55	+125	°C
Junction temperature	T _J		+150	°C
Thermal resistance	Θ _{JC}		29	°C/W

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal values. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

Table 3. SKY65173-70LF Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Units
Supply voltage	V _{CC}	4.75	5.0	5.5	V
Operating frequency	f	850		1000	MHz
Operating case temperature	T _C	-40	+25	+85	°C

Electrical and Mechanical Specifications

Signal pin assignments and functional pin descriptions are described in Table 1. The absolute maximum ratings of the SKY65173-70LF are provided in Table 2. The recommended operating conditions are specified in Table 3 and electrical specifications are provided in Table 4.

Typical performance characteristics of the SKY65173-70LF are illustrated in Figures 3 to 13.

Table 4. SKY65173-70LF Electrical Characteristics (Note 1)
(V_{CC} = +5 V, T_c = 25 °C, f = 920 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Conditions	Min	Typical	Max	Units
Frequency	f		869	920	960	MHz
Quiescent current	I _{CCQ}		130	156	185	mA
Operational current	I _{OP}	@P1dB		235	300	mA
Input return loss	IS11l		10	13		dB
Small signal gain	IS21l		15.0	16.5	17.5	dB
Output return loss	IS22l		10	15		dB
Third Order Output Intercept Point	OIP3	P _{IN} = -10 dBm, 1 MHz spacing	+41	+44		dBm
Noise Figure	NF			2.6	3.0	dB
1 dB compression point	P1dB		+25.5	+26.5		dBm

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Characteristics

(V_{CC} = +5 V, T_c = 25 °C, f = 920 MHz, Characteristic Impedance [Z₀] = 50 Ω, Unless Otherwise Noted)

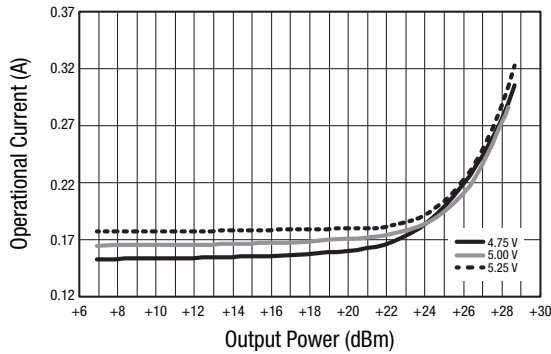


Figure 3. Operational Current vs Output Power Over Supply Voltage

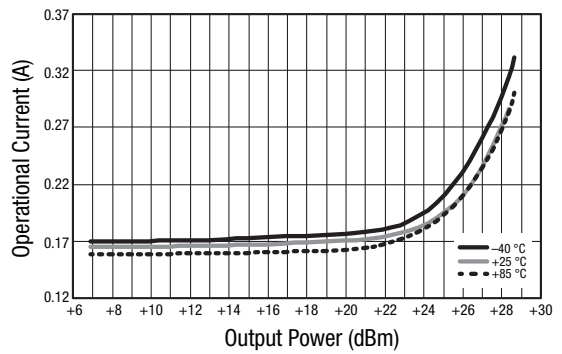


Figure 4. Operational Current vs Output Power Over Temperature

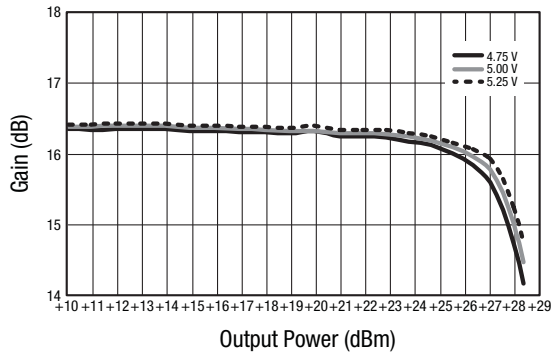


Figure 5. Gain vs Output Power Over Supply Voltage

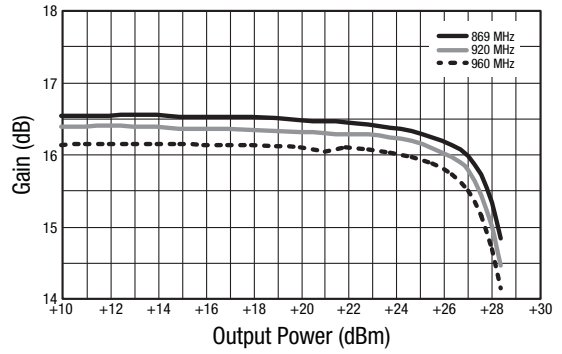


Figure 6. Gain vs Output Power Over Frequency

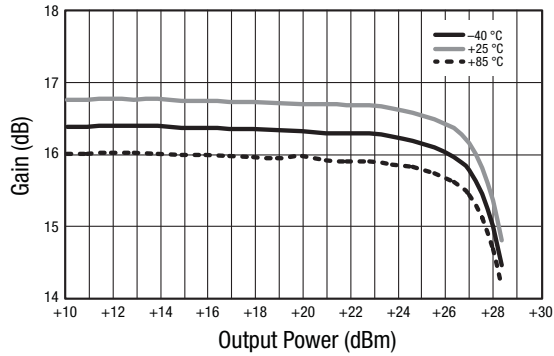


Figure 7. Gain vs Output Power Over Temperature

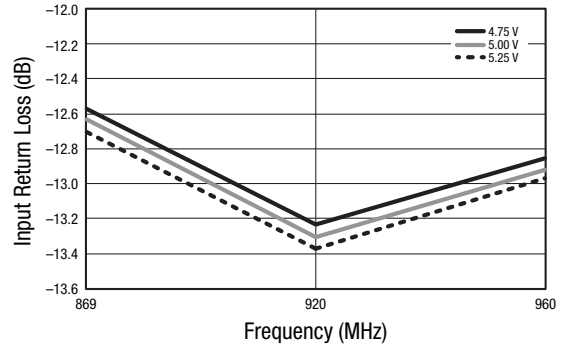


Figure 8. Input Return Loss vs Frequency Over Supply Voltage

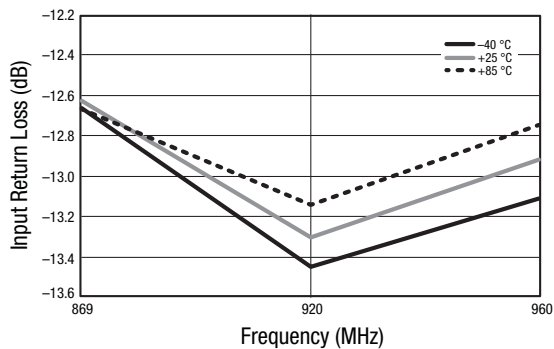


Figure 9. Input Return Loss vs Frequency Over Temperature

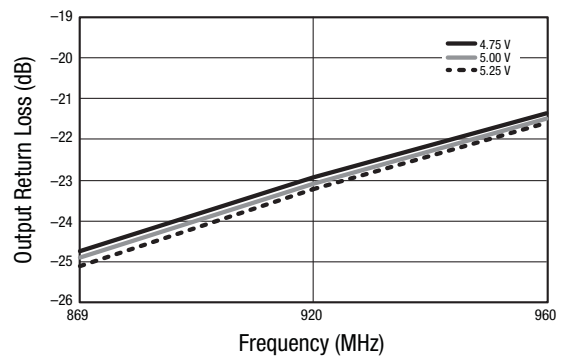


Figure 10. Output Return Loss vs Frequency Over Supply Voltage

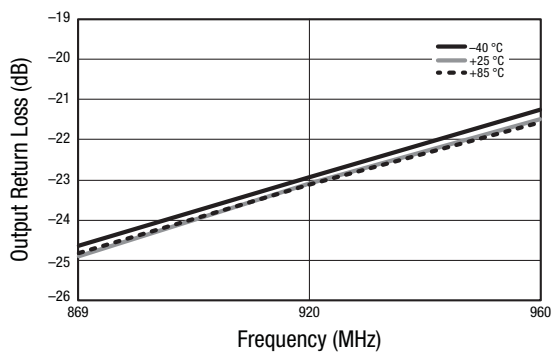


Figure 11. Output Return Loss vs Frequency Over Temperature

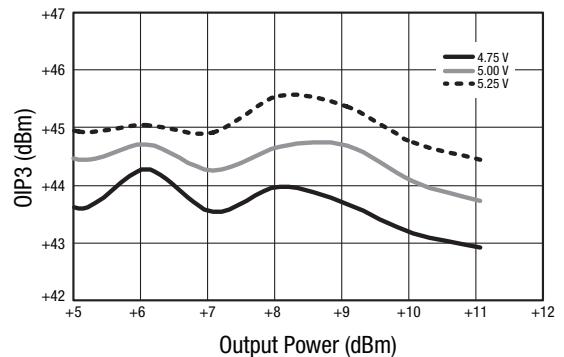


Figure 12. OIP3 vs Output Power Over Supply Voltage

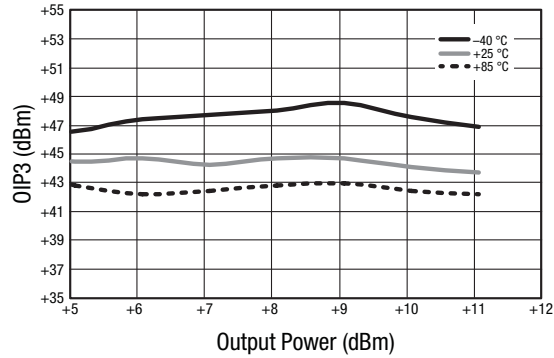


Figure 13. OIP3 vs Output Power Over Temperature

Evaluation Board Description

The Skyworks SKY65173-70LF Evaluation Board is used to test the performance of the SKY65173-70LF PA driver. An assembly drawing for the Evaluation Board is shown in Figure 14 and the layer detail is provided in Figure 15. The layer detail physical characteristics are noted in Figure 16.

As shown in Figure 17, capacitors C7, C8, and C9 provide DC bias decoupling for Vcc. Pins 1 and 3 are the RF input and output signals, respectively. External DC blocking is required on the input and output, but can be implemented as part of the RF matching circuit. Pin 2 and the package backside metal, pin 4, are ground pins that provide the DC and RF ground, respectively.

Circuit Design Considerations

The following design considerations are general in nature and must be followed regardless of final use or configuration.

1. Paths to ground should be made as short as possible.
2. The ground pad of the SKY65173-70LF PA has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the amplifier. As such, design the connection to the ground pad to dissipate the maximum wattage produced to the circuit board. Multiple vias to the grounding layer are required.

NOTE: Junction temperature (T_j) of the device increases with a poor connection to the slug and ground. This reduces the lifetime of the device.

A suggested matching circuit is shown in Figure 17. Component values for the SKY65173-70LF Evaluation Board are listed in Table 5.

Testing Procedure

Use the following procedure to set up the SKY65173-70LF Evaluation Board for testing:

1. Connect a 5.0 V supply to Vcc. If available, enable the current limiting function of the power supply to 400 mA.
2. Connect a signal generator to the RF signal input port. Set it to the desired RF frequency at a power level of -15 dBm or less to the Evaluation Board but do NOT enable the RF signal.
3. Connect a spectrum analyzer to the RF signal output port.
4. Enable the power supply.
5. Enable the RF signal.
6. Take measurements.

CAUTION: If any of the output signals exceed the rated maximum values, the SKY65173-70LF Evaluation Board can be permanently damaged.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65173-70LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Package Dimensions

Package dimensions for the 4-pin SOT-89 are shown in Figure 18, and tape and reel dimensions are provided in Figure 19.

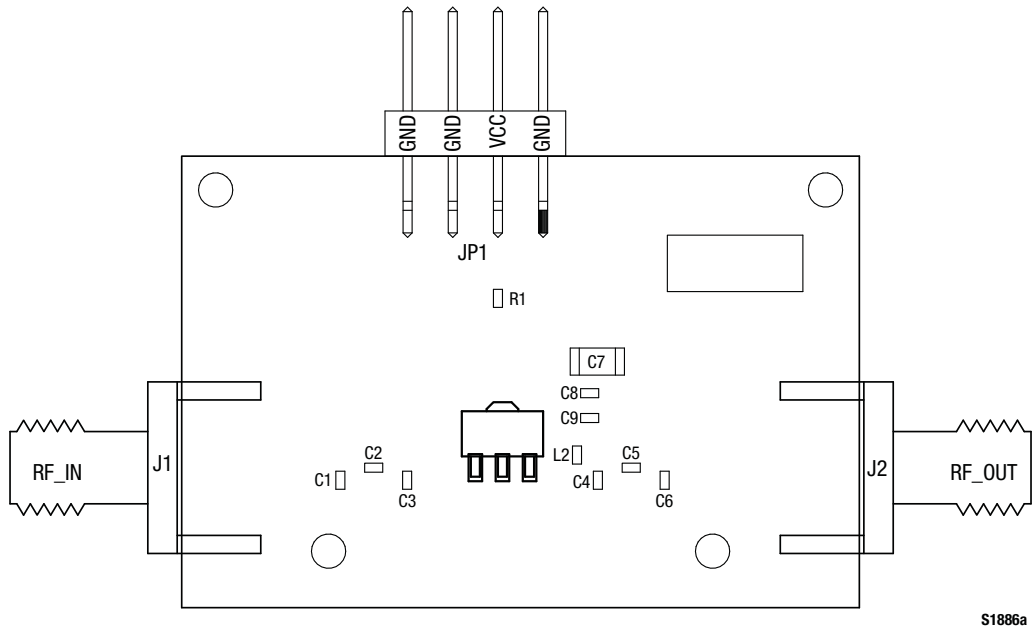
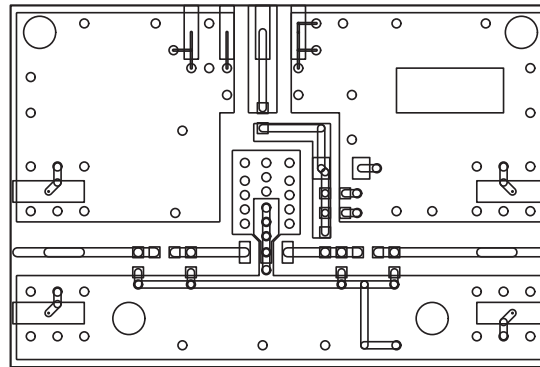
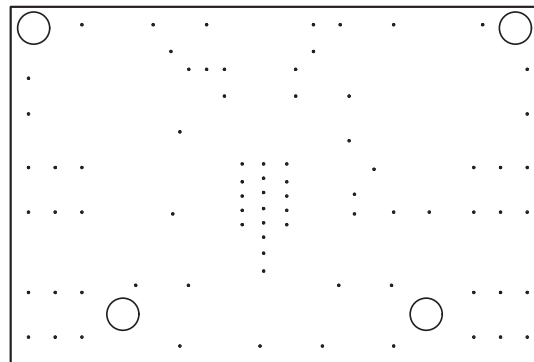


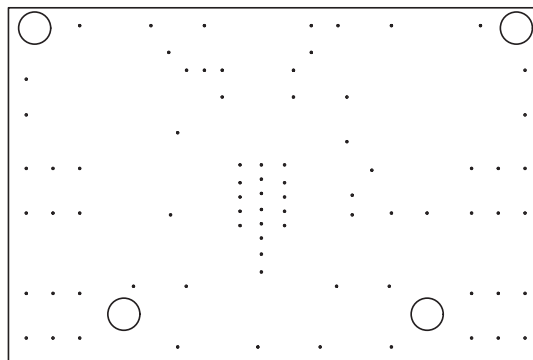
Figure 14. Evaluation Board Assembly Drawing



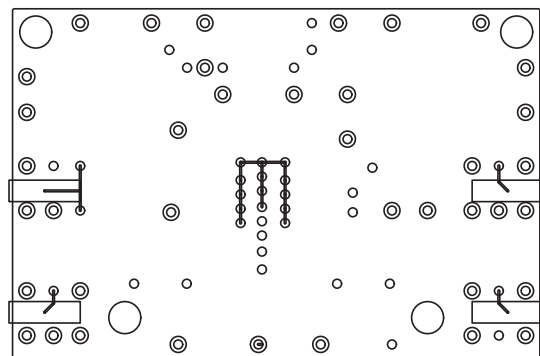
Layer 1: Top - Metal



Layer 2: Ground









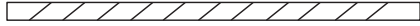
Layer 3: Ground



Layer 4: Solid Ground Plane

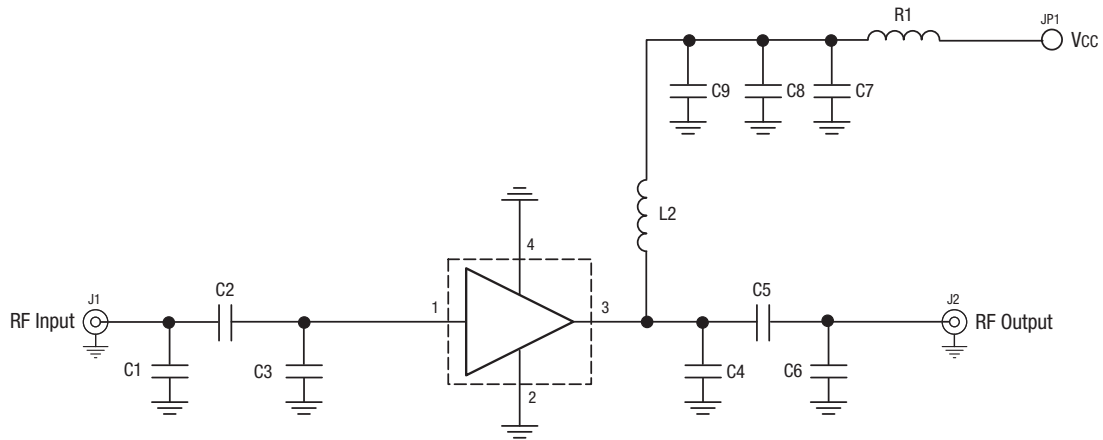
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Figure 15. Evaluation Board Layer Detail

Cross Section	Name	Thickness (mils)	Material	ϵ_r
	L1	1.4	Cu, 1 oz.	-
	Lam1	12	Rogers 4003-12	3.38
	L2	1.4	Cu, 1 oz.	-
	Lam2	4	FR4-4	4.35
	L3	1.4	Cu, 1 oz.	-
	Lam3	12	FR4-12	4.35
	L4	1.4	Cu, 1 oz.	-

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Figure 16. Layer Detail Physical Characteristics



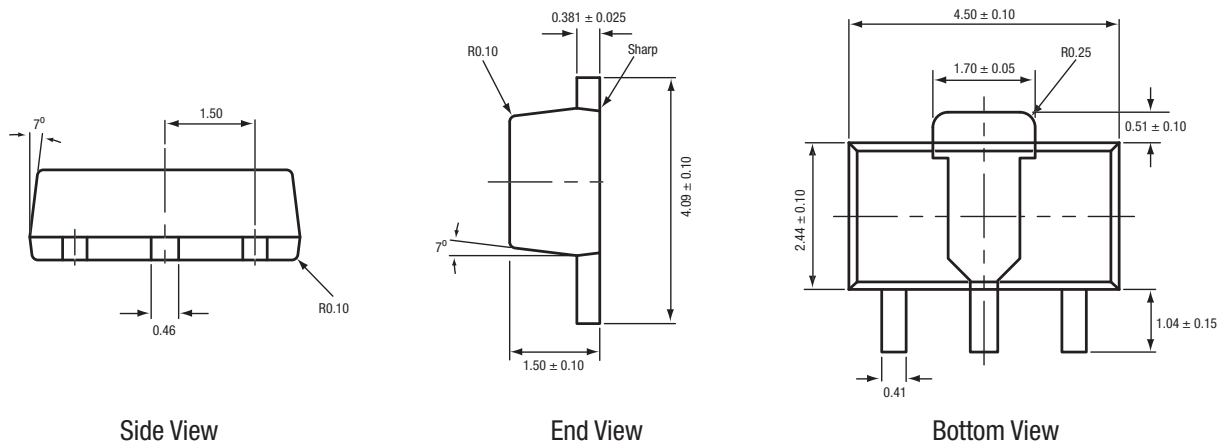
NOTE: Some component labels may be different than the corresponding component symbol shown here. Component values, however, are accurate as of the date of this Data Sheet.

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Figure 17. SKY65173-70LF Evaluation Board Schematic

Table 5. SKY65173-70LF Evaluation Board Bill of Materials

Component	Size	Value	Vendor	Notes
C1	0402	4.3 nH	Murata	Wire wound, hi-Q inductor, ± 0.1 nH tolerance
C2	0402	4.3 pF	Johanson	Wire wound, hi-Q capacitor, low ESR, ± 0.1 pF tolerance
C3	0402	DNI	-	
C4	0402	DNI	-	
C5	0402	4.3 pF	Johanson	Wire wound, hi-Q capacitor, low ESR, ± 0.1 pF tolerance
C6	0402	5.1 nH	Murata	Wire wound, hi-Q inductor, ± 0.1 nH tolerance
C7	1206	1 μ F	-	Ceramic capacitor, 10% tolerance
C8	0402	DNI	-	
C9	0402	1000 pF	-	Ceramic capacitor, 10% tolerance
L2	0402	8.2 nH	Murata	Wire wound, hi-Q inductor, 2% tolerance
R1	0402	0 Ω	-	

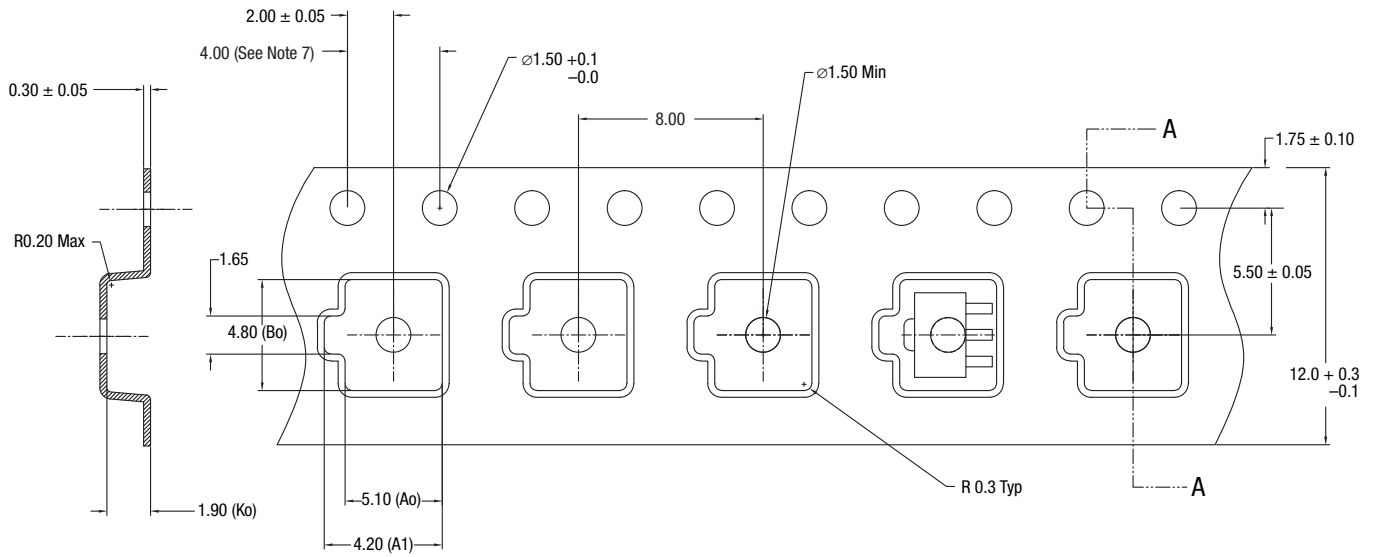


All measurements are in millimeters

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Figure 18. SKY65173-70LF (4-Pin SOT-89) Package Dimensions

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Notes:

1. Carrier tapes must meet all requirements of Skyworks GP01-D233 procurement spec for tape and reel shipping.
2. Carrier tape material: black conductive polycarbonate or polystyrene.
3. Cover tape material: transparent conductive PSA.
Cover tape size: 9.2 mm width.
4. Typical ESD surface resistivity must meet all ESD requirements of Skyworks specified in GP01-D233.
5. Ao and Bo measurement point to be 0.30 mm from bottom pocket.
6. All measurements are in millimeters.
7. 10-sprocket hole pitch cumulative tolerance 0.2 mm.

200953-100

Figure 19. SKY65173-70LF Tape and Reel Dimensions

Ordering Information

Model Name	Ordering Part Number	Evaluation Board Part Number
SKY65173-70LF Low-Noise PA Driver	SKY65173-70LF	TW13-D280

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